

PHOTOSENSITIVE RESIN COMPOSITION, CURED PRODUCT, DISPLAY
DEVICE, AND ELECTRONIC COMPONENT

ABSTRACT

The purpose of the present invention is to provide: a photosensitive resin composition which has good solubility in a thinner, which can suppress contamination of an opening part after being cured and suppress foaming during lamination, and from which a cured product having good light emission characteristics even after being subjected to a reliability test is obtained; a cured product obtained by curing the photosensitive resin composition; and a display device and an electronic component equipped with a cured product of the resin composition. A photosensitive resin composition according to the present invention contains: a resin (A) including a specific structural unit (hereinafter referred to as resin (A)); a photosensitive agent (B); and a solvent (C). When the total amount of diamine residues in the resin (A) is defined as 100 mol%, the total of the content of a specific diamine residue is 30-100 mol%.

[No Suitable Figure]